

## Dual 3-Input 3-Output OR Gate

The MC10H210 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10H210 particularly useful in clock distribution applications where minimum clock skew is desired.

- Propagation Delay Average, 1.0 ns Typical
- Power Dissipation, 160 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

### MAXIMUM RATINGS

| Characteristic                                  | Symbol    | Rating                     | Unit     |
|-------------------------------------------------|-----------|----------------------------|----------|
| Power Supply ( $V_{CC} = 0$ )                   | $V_{EE}$  | -8.0 to 0                  | Vdc      |
| Input Voltage ( $V_{CC} = 0$ )                  | $V_I$     | 0 to $V_{EE}$              | Vdc      |
| Output Current— Continuous<br>— Surge           | $I_{out}$ | 50<br>100                  | mA       |
| Operating Temperature Range                     | $T_A$     | 0 to +75                   | °C       |
| Storage Temperature Range— Plastic<br>— Ceramic | $T_{stg}$ | -55 to +150<br>-55 to +165 | °C<br>°C |

### ELECTRICAL CHARACTERISTICS ( $V_{EE} = -5.2 \text{ V} \pm 5\%$ ) (See Note)

| Characteristic       | Symbol    | 0°    |       | 25°   |       | 75°   |        | Unit          |
|----------------------|-----------|-------|-------|-------|-------|-------|--------|---------------|
|                      |           | Min   | Max   | Min   | Max   | Min   | Max    |               |
| Power Supply Current | $I_E$     | —     | 42    | —     | 38    | —     | 42     | mA            |
| Input Current High   | $I_{inH}$ | —     | 720   | —     | 450   | —     | 450    | $\mu\text{A}$ |
| Input Current Low    | $I_{inL}$ | 0.5   | —     | 0.5   | —     | 0.3   | —      | $\mu\text{A}$ |
| High Output Voltage  | $V_{OH}$  | -1.02 | -0.84 | -0.98 | -0.81 | -0.92 | -0.735 | Vdc           |
| Low Output Voltage   | $V_{OL}$  | -1.95 | -1.63 | -1.95 | -1.63 | -1.95 | -1.60  | Vdc           |
| High Input Voltage   | $V_{IH}$  | -1.17 | -0.84 | -1.13 | -0.81 | -1.07 | -0.735 | Vdc           |
| Low Input Voltage    | $V_{IL}$  | -1.95 | -1.48 | -1.95 | -1.48 | -1.95 | -1.45  | Vdc           |

### AC PARAMETERS

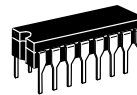
|                   |          |      |      |      |      |     |     |    |
|-------------------|----------|------|------|------|------|-----|-----|----|
| Propagation Delay | $t_{pd}$ | 0.5  | 1.55 | 0.55 | 1.55 | 0.6 | 1.7 | ns |
| Rise Time         | $t_r$    | 0.75 | 1.8  | 0.75 | 1.9  | 0.8 | 2.0 | ns |
| Fall Time         | $t_f$    | 0.75 | 1.8  | 0.75 | 1.9  | 0.8 | 2.0 | ns |

#### NOTE:

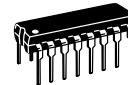
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

Note: If crosstalk is present, double bypass capacitor to 0.2  $\mu\text{F}$ .

## MC10H210



**L SUFFIX**  
CERAMIC PACKAGE  
CASE 620-10

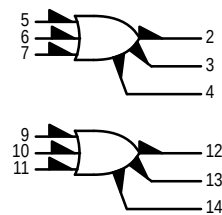


**P SUFFIX**  
PLASTIC PACKAGE  
CASE 648-08



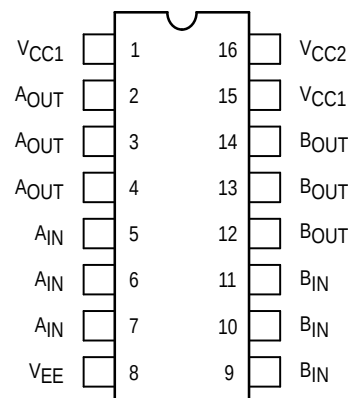
**FN SUFFIX**  
PLCC  
CASE 775-02

### LOGIC DIAGRAM



$V_{CC1} = \text{PINS } 1, 15$   
 $V_{CC2} = \text{PIN } 16$   
 $V_{EE} = \text{PIN } 8$

### DIP PIN ASSIGNMENT

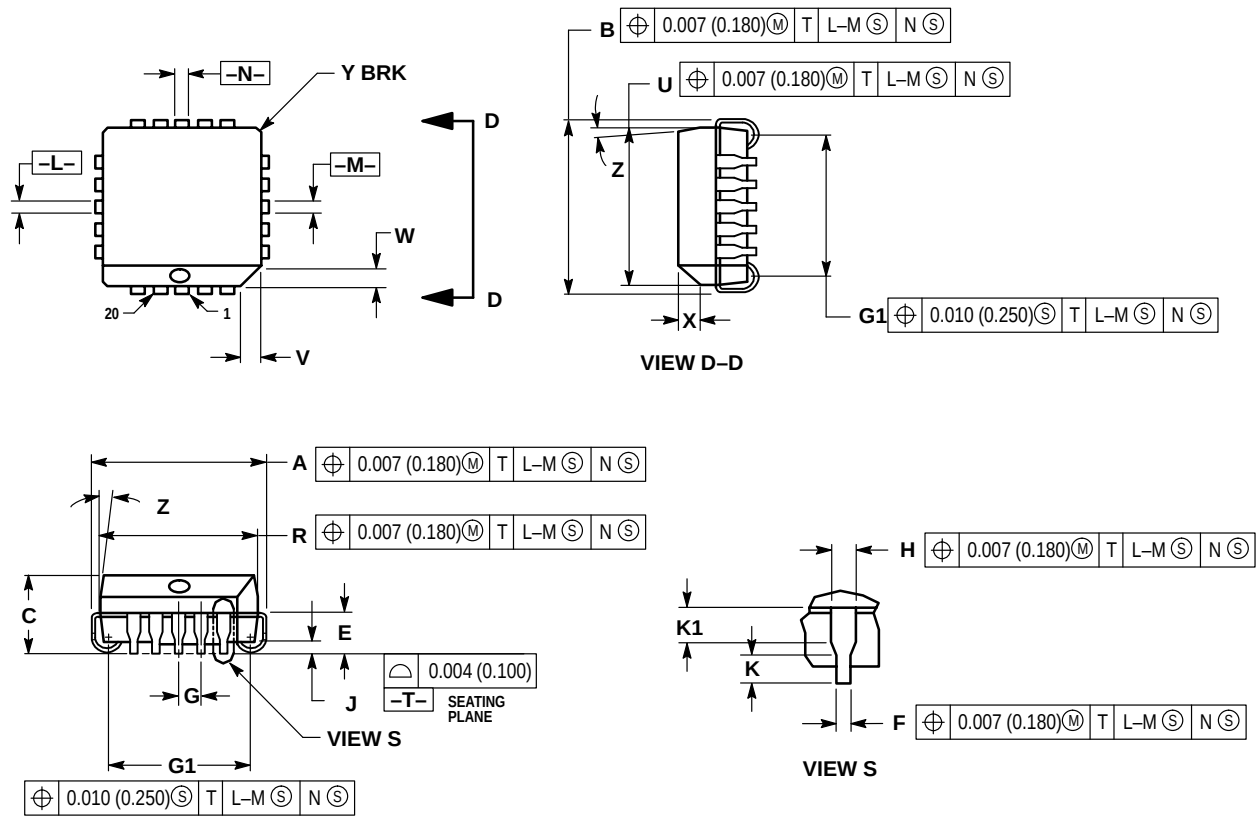


Pin assignment is for Dual-in-Line Package.  
For PLCC pin assignment, see the Pin Conversion  
Tables on page 6-11 of the Motorola MECL Data  
Book (DL122/D).



OUTLINE DIMENSIONS

FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 775-02  
ISSUE C

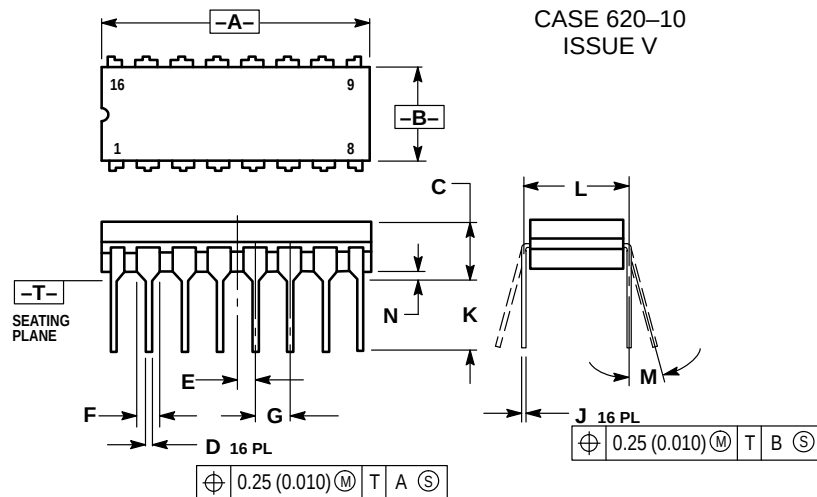


- NOTES:
1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
  2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
  3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
  4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  5. CONTROLLING DIMENSION: INCH.
  6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
  7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.385     | 0.395 | 9.78        | 10.03 |
| B   | 0.385     | 0.395 | 9.78        | 10.03 |
| C   | 0.165     | 0.180 | 4.20        | 4.57  |
| E   | 0.090     | 0.110 | 2.29        | 2.79  |
| F   | 0.013     | 0.019 | 0.33        | 0.48  |
| G   | 0.050 BSC |       | 1.27 BSC    |       |
| H   | 0.026     | 0.032 | 0.66        | 0.81  |
| J   | 0.020     | —     | 0.51        | —     |
| K   | 0.025     | —     | 0.64        | —     |
| R   | 0.350     | 0.356 | 8.89        | 9.04  |
| U   | 0.350     | 0.356 | 8.89        | 9.04  |
| V   | 0.042     | 0.048 | 1.07        | 1.21  |
| W   | 0.042     | 0.048 | 1.07        | 1.21  |
| X   | 0.042     | 0.056 | 1.07        | 1.42  |
| Y   | —         | 0.020 | —           | 0.50  |
| Z   | 2 °       | 10 °  | 2 °         | 10 °  |
| G1  | 0.310     | 0.330 | 7.88        | 8.38  |
| K1  | 0.040     | —     | 1.02        | —     |

## OUTLINE DIMENSIONS

**L SUFFIX**  
**CERAMIC DIP PACKAGE**  
**CASE 620-10**  
**ISSUE V**

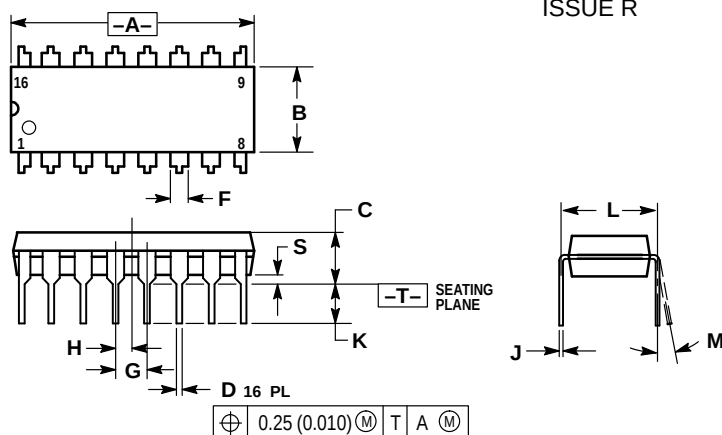


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.750     | 0.785 | 19.05       | 19.93 |
| B   | 0.240     | 0.295 | 6.10        | 7.49  |
| C   | —         | 0.200 | —           | 5.08  |
| D   | 0.015     | 0.020 | 0.39        | 0.50  |
| E   | 0.050 BSC |       | 1.27 BSC    |       |
| F   | 0.055     | 0.065 | 1.40        | 1.65  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.125     | 0.170 | 3.18        | 4.31  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 15°   | 0°          | 15°   |
| N   | 0.020     | 0.040 | 0.51        | 1.01  |

**P SUFFIX**  
**PLASTIC DIP PACKAGE**  
**CASE 648-08**  
**ISSUE R**



## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.740     | 0.770 | 18.80       | 19.55 |
| B   | 0.250     | 0.270 | 6.35        | 6.85  |
| C   | 0.145     | 0.175 | 3.69        | 4.44  |
| D   | 0.015     | 0.021 | 0.39        | 0.53  |
| F   | 0.040     | 0.70  | 1.02        | 1.77  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.050 BSC |       | 1.27 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.110     | 0.130 | 2.80        | 3.30  |
| L   | 0.295     | 0.305 | 7.50        | 7.74  |
| M   | 0°        | 10°   | 0°          | 10°   |
| S   | 0.020     | 0.040 | 0.51        | 1.01  |

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and  are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

## How to reach us:

**USA/EUROPE/Locations Not Listed:** Motorola Literature Distribution;  
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447 or 602-303-5454

**MFAX:** RMFA00@email.sps.mot.com – TOUCHTONE 602-244-6609  
**INTERNET:** http://Design-NET.com

**JAPAN:** Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, 6F Seibu-Butsuryu-Center,  
3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-81-3521-8315

**ASIA/PACIFIC:** Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,  
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

